

MULTIPLE CONFIGURATION PCB HEADERS & **RECEPTACLES**





✓ Active



PRODUCT DRAWING



↓ 3D PDF

TE CONNECTIVITY (TE)

14 MODII HDR DRST UNSHRD .100

AMPMODU | AMPMODU Headers

87215-4

TE Internal Number: 87215-4

Always EU RoHS/ELV Compliant

Applies To Printed Circuit Board

Connector Style Plug

Centerline 2.54 mm [.1 in]

Number of Positions 14

Header Type Unshrouded

Product Drawings

ASSEMBLY, MOD II, HEADER, DOUBLE ROW, .100 X .100 CL. VERTICAL, .025

SQUARE POSTS

PDF **English**

CAD Files

Customer View Model

2D_DXF.ZIP English

Customer View Model

3D_IGS.ZIP English

Customer View Model

3D_STP.ZIP English

3D PDF PDF English

Catalog Pages/Data Sheets

AMPMODU_INTERCONNECTION_SYSTEM_SECTION5

PDF **English**

Product Environmental Compliance

TE Material Declaration

MD_87215-4_09092011749

PDF **English**

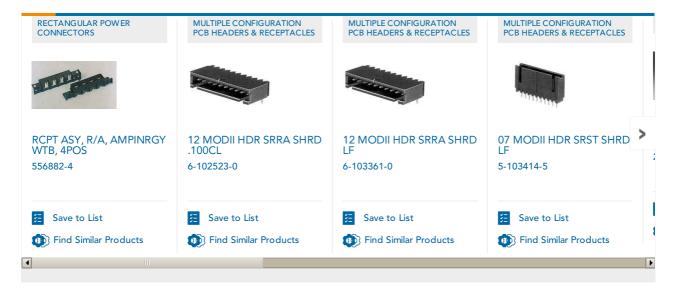
Please review product documents or contact us for the latest agency approval information. Please Note: Use the Product Drawing for all design activity.

Product Type Features Printed Circuit Board Applies To

	Connector Style	Plug
	PCB Mounting Orientation	Vertical
	Connector Type	Header
	Row-to-Row Spacing	2.54 mm [.1 in]
	Stabilizers	Without
	Strain Relief	Without
	Board Standoff	Without
	Product Type	Connector
	Gasket	Without
Configuration Features	Number of Positions	14
	Number of Rows	2
	Keyed	No
	Selectively Loaded	No
Electrical Characteristics	Dielectric Withstanding Voltage	750 Vrms
Body Features	Header Type	Unshrouded
	Post Size	.64 mm [.025 in]
• • • • • • • • • • • • • • • • • • • •		
Contact Features	Contact Protection	Without
Contact Features	Contact Shape	Square
Contact Features	Contact Shape Contact Type	Square Pin
Contact Features	Contact Shape Contact Type Contact Base Material	Square Pin Phosphor Bronze
Contact Features	Contact Shape Contact Type Contact Base Material Contact Mating Area Plating Thickness (µin)	Square Pin Phosphor Bronze 30
Contact Features	Contact Shape Contact Type Contact Base Material Contact Mating Area Plating Thickness (µin) Solder Tail Contact Plating Material	Square Pin Phosphor Bronze 30 Gold Flash over Nickel
Contact Features	Contact Shape Contact Type Contact Base Material Contact Mating Area Plating Thickness (µin) Solder Tail Contact Plating Material Contact Mating Area Plating Material	Square Pin Phosphor Bronze 30 Gold Flash over Nickel Gold
Contact Features	Contact Shape Contact Type Contact Base Material Contact Mating Area Plating Thickness (µin) Solder Tail Contact Plating Material	Square Pin Phosphor Bronze 30 Gold Flash over Nickel
Contact Features Termination Features	Contact Shape Contact Type Contact Base Material Contact Mating Area Plating Thickness (µin) Solder Tail Contact Plating Material Contact Mating Area Plating Material	Square Pin Phosphor Bronze 30 Gold Flash over Nickel Gold
	Contact Shape Contact Type Contact Base Material Contact Mating Area Plating Thickness (µin) Solder Tail Contact Plating Material Contact Mating Area Plating Material Contact Current Rating (A)	Square Pin Phosphor Bronze 30 Gold Flash over Nickel Gold 3
	Contact Shape Contact Type Contact Base Material Contact Mating Area Plating Thickness (µin) Solder Tail Contact Plating Material Contact Mating Area Plating Material Contact Current Rating (A) Termination Post Length	Square Pin Phosphor Bronze 30 Gold Flash over Nickel Gold 3 3.18 mm [.125 in]
	Contact Shape Contact Type Contact Base Material Contact Mating Area Plating Thickness (µin) Solder Tail Contact Plating Material Contact Mating Area Plating Material Contact Current Rating (A) Termination Post Length Termination End Plating Material Termination Method to PC Board	Square Pin Phosphor Bronze 30 Gold Flash over Nickel Gold 3 3.18 mm [.125 in] Gold Over Nickel Through Hole
Termination Features	Contact Shape Contact Type Contact Base Material Contact Mating Area Plating Thickness (µin) Solder Tail Contact Plating Material Contact Mating Area Plating Material Contact Current Rating (A) Termination Post Length Termination End Plating Material	Square Pin Phosphor Bronze 30 Gold Flash over Nickel Gold 3 3.18 mm [.125 in] Gold Over Nickel
Termination Features	Contact Shape Contact Type Contact Base Material Contact Mating Area Plating Thickness (µin) Solder Tail Contact Plating Material Contact Mating Area Plating Material Contact Current Rating (A) Termination Post Length Termination End Plating Material Termination Method to PC Board PCB Mounting Style PCB Mount Retention	Square Pin Phosphor Bronze 30 Gold Flash over Nickel Gold 3 3.18 mm [.125 in] Gold Over Nickel Through Hole Without
Termination Features	Contact Shape Contact Type Contact Base Material Contact Mating Area Plating Thickness (µin) Solder Tail Contact Plating Material Contact Mating Area Plating Material Contact Current Rating (A) Termination Post Length Termination End Plating Material Termination Method to PC Board	Square Pin Phosphor Bronze 30 Gold Flash over Nickel Gold 3 3.18 mm [.125 in] Gold Over Nickel Through Hole

	Mating Connector Lock	Without
Housing Features	Centerline Housing Color Housing Material	2.54 mm [.1 in] Black Thermoplastic
Dimensions	PCB Thickness (Recommended) Mating Post Length	1.397 mm [.055 in] 8.08 mm [.318 in]
Usage Conditions	Operating Temperature Range (°C) High Temperature Housing	-65 – 105 No
Operation/Application	High Speed Serial Data Connector	No
Industry Standards	UL Flammability Rating Approved Standards	UL 94V-0 CSA LR7189, UL E28476
Packaging Features	Packaging Quantity Packaging Method	100 Carton
Product Compliance	Statement of Compliance	

CUSTOMERS ALSO BOUGHT



VIEW ALL PRODUCT COMPLIANCE